

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3749157

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUN WANG	01/30/2016
OZCAN OZTURK	02/09/2016
MIGUEL GRIOT	02/09/2016
RAVINDRA MANOHAR PATWARDHAN	02/09/2016
ONKAR JAYANT DABEER	02/09/2016
MADHAVAN SRINIVASAN VAJAPEYAM	02/11/2016
JELENA DAMNJANOVIC	02/11/2016
ALEKSANDAR DAMNJANOVIC	02/10/2016
TAESANG YOO	02/12/2016
YONGBIN WEI	02/09/2016
DURGA PRASAD MALLADI	02/12/2016

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	62078210
Application Number:	14937017

CORRESPONDENCE DATA

Fax Number: (303)473-2720

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3034732700

Email: cesimon@hollandhart.com

Correspondent Name: MICHAEL DRAPKIN

Address Line 1: P.O. BOX 11583

Address Line 4: SALT LAKE CITY, UTAH 84147

PATENT

ATTORNEY DOCKET NUMBER:	PQ340.01 (81679.1133)
NAME OF SUBMITTER:	MICHAEL DRAPKIN
SIGNATURE:	/Michael L. Drapkin/
DATE SIGNED:	02/22/2016

Total Attachments: 8

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ASSIGNMENT

WHEREAS, WE,

1. **Jun Wang**, a citizen of the United States of America, having a mailing address located at 17704 Vineyard Lane, Poway, California, 92064, and a resident of Poway, California,
2. **Ozcan Ozturk**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
3. **Miguel Griot**, a citizen of Italy, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of La Jolla, California,
4. **Ravindra Manohar Patwardhan**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
5. **Onkar Jayant Dabeer**, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
6. **Madhavan Srinivasan Vajapeyam**, a citizen of United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,
7. **Jelena Damnjanovic**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of Del Mar, California,
8. **Aleksandar Damnjanovic**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of Del Mar, California,
9. **Taesang Yoo**, a citizen of the Republic of Korea, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of Riverside, California,
10. **Yongbin Wei**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of La Jolla, California,
11. **Durga Prasad Malladi**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to SELECTED IP FLOW ULTRA LOW LATENCY (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/937,017 filed November 10, 2015, Qualcomm Reference No. 147391, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/078,210, filed November 11, 2014, Qualcomm Reference No. 147391P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said

ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 1/30/2016
LOCATION DATE

Jun Wang

Done at _____, on _____
LOCATION DATE
Ozcan Ozturk

Done at _____, on _____
LOCATION DATE
Miguel Griot

Done at _____, on _____
LOCATION DATE
Ravindra Manohar Patwardhan

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Onkar Jayant Daheer

Done at _____, on _____
LOCATION DATE Madhavan Srinivasan Vajapeyam

Done at _____, on _____
LOCATION DATE Jelena Damnjanovic

Done at _____, on _____
LOCATION DATE Aleksandar Damnjanovic

Done at _____, on _____
LOCATION DATE Taesang Yoo

Done at _____, on _____
LOCATION DATE Yongbin Wei

Done at _____, on _____
LOCATION DATE Durga Prasad Malladi

ASSIGNMENT

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10. **Yongbin Wei**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of La Jolla, California,
11. **Durga Prasad Malladi**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, California, 92121-1714, and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to SELECTED IP FLOW ULTRA LOW LATENCY (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/937,017 filed November 10, 2015, Qualcomm Reference No. 147391, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 62/078,210, filed November 11, 2014, Qualcomm Reference No. 147391P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said

ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

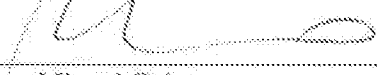
AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

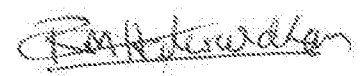
AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
LOCATION DATE Jun Wang


Done at San Diego, on 2/9/16
LOCATION DATE 
Ozcan Ozturk

Done at SAN DIEGO, on 02/09/2016
LOCATION DATE 
Miguel Griot

Done at SAN DIEGO, on 02/09/2016
LOCATION DATE 
Ravindra Manohar Patwardhan

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 2/9/16
LOCATION DATE


Onkar Jayant Dabeer

Done at San Diego, on 02/09/16
LOCATION DATE


Madhavan Srinivasan Vajapeyam

Done at San Diego, on 2/11/16
LOCATION DATE


Jelena Damjanovic


Done at San Diego, on 2/10/16
LOCATION DATE


Aleksandar Damjanovic

Done at San Diego, on 2/12/16
LOCATION DATE


Taesang Yoo

Done at San Diego, on 2/9/16
LOCATION DATE


Yongbin Wei

Done at San Diego, on 2/12/16
LOCATION DATE


Durga Prasad Malladi